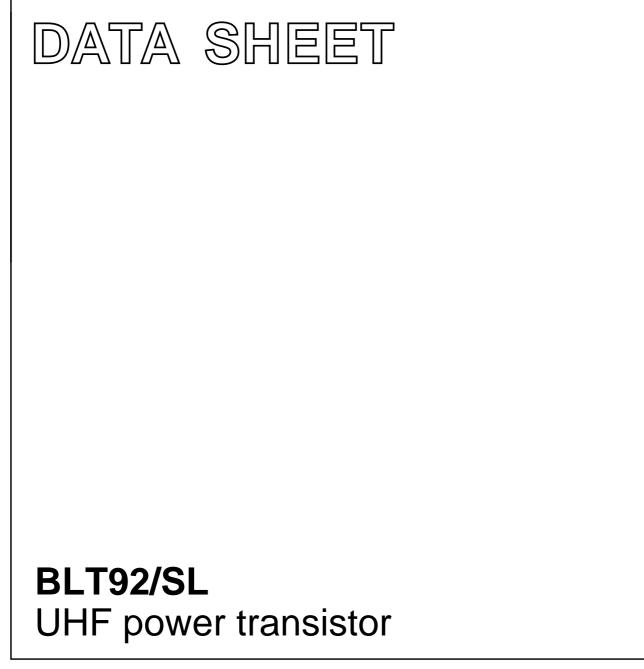
DISCRETE SEMICONDUCTORS



Product specification

May 1989



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DESCRIPTION

NPN silicon planar epitaxial transistor primarily intended for use in handheld radio stations in the 900 MHz communications band.

This device has been designed specifically for class-B operation.

FEATURES

- internal input matching capacitor for a high power gain
- gold metallization ensures excellent reliability

The transistor has a 4-lead studless envelope with a ceramic cap (SOT122D). All leads are isolated from the mounting base.

PINNING

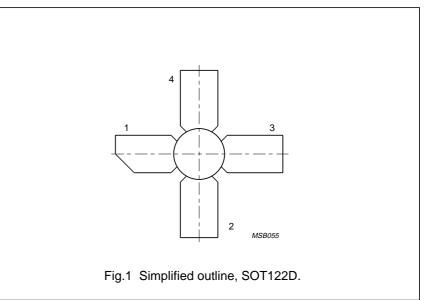
- 1 = collector
- 2 = emitter
- 3 = base
- 4 = emitter

QUICK REFERENCE DATA

RF performance at T_{mb} = 25 °C in a common-emitter class-B circuit

MODE OF OPERATION	V _{CE}	f	P _L	G _p	ղշ
	(V)	(MHz)	(W)	(dB)	(%)
CW (class-B)	7.5	900	3.0	> 7.0	> 50

PIN CONFIGURATION



PRODUCT SAFETY This device incorporates beryllium oxide (BeO), the dust of which is toxic. The device is entirely safe provided that the internal BeO disc is not damaged.

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RATINGS

NAMOO				
Limiting values in accordance with the Absolute Maximum System (IEC	C 134)			
Collector-base voltage (open emitter)	V _{CBO}	max.	20	V
Collector-emitter voltage (open base)	V _{CEO}	max.	10	V
Emitter-base voltage (open collector)	V _{EBO}	max.	3.0	V
Collector current				
DC or average	I _C ; I _{C(AV)}	max.	1.2	А
(peak value); f > 800 MHz	I _{CM}	max.	3.6	А
Total power dissipation				
at T _{amb} < 120 °C; f > 800 MHz	P _{tot}	max.	10	W
Storage temperature range	T _{stg}	–65 to	+150	°C
Operating junction temperature	Тj	max.	200	°C

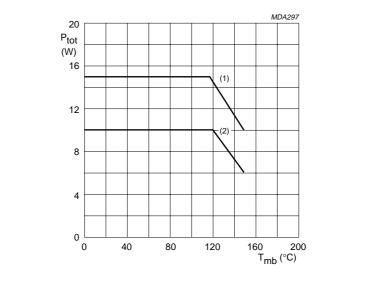
THERMAL RESISTANCE

Dissipation =	10 W;	T _{mb} =	25 °C
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From junction to mounting base (f > 800 MHz)

R_{th j-mb(RF)} max. 6.0

6.0 K/W



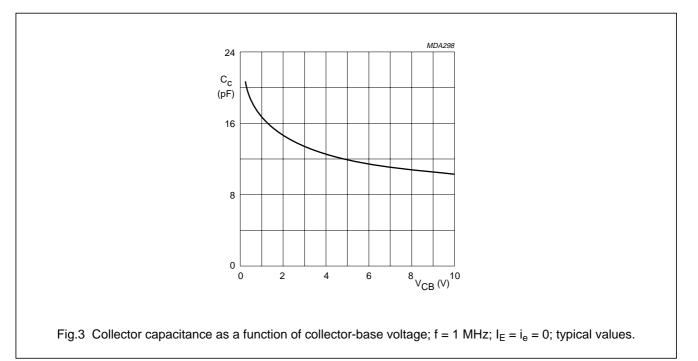
(1) Short-time RF operation during mismatch (f $>\,800$ MHz).

(2) Continuous RF operation (f > 800 MHz).

Fig.2 Total power dissipation as a function of temperature.

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CHARACTERISTICS				
$T_j = 25 \text{ °C}$ unless otherwise specified				
Collector-base breakdown voltage				
open emitter; $I_C = 10 \text{ mA}$	V _{(BR)CBO}	>	20 V	/
Collector-emitter breakdown voltage				
open base; I _C = 20 mA	V _{(BR)CEO}	>	10 V	/
Emitter-base breakdown voltage				
open collector; $I_E = 2 \text{ mA}$	V _{(BR)EBO}	>	3.0 V	/
Collector cut-off current				
V _{BE} = 0; V _{CE} = 10 V	I _{CES}	<	5.0 n	nA
Second breakdown energy				
L = 25 mH; f = 50 Hz; R_{BE} = 10 Ω	E _{SBR}	>	1.0 n	nJ
DC current gain				
$I_{C} = 600 \text{ mA}; V_{CE} = 5 \text{ V}$	h _{FE}	>	25	
Collector capacitance at f = 1 MHz				
$I_{E} = i_{e} = 0; V_{CB} = 7.5 V$	C _c	typ.	11 p	νF
Feedback capacitance at f = 1 MHz				
$I_{C} = 0; V_{CE} = 7.5 V$	C _{re}	typ.	6.0 p	νF
Collector-mounting base capacitance	C_{c-mb}	typ.	1.2 p	νF

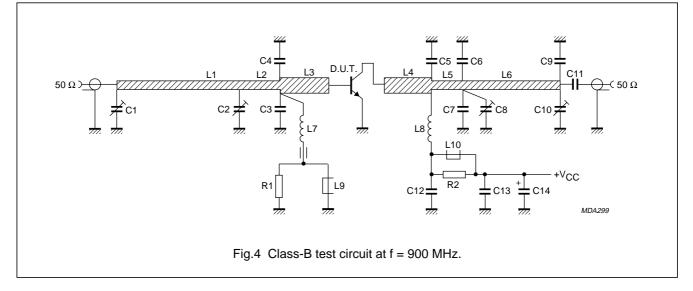


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APPLICATION INFORMATION

RF performance in CW operation (common-emitter circuit; class-B); f = 900 MHz; T_{mb} = 25 °C

MODE OF OPERATION	V _{CE} (V)	P _L (W)		G _p (dB)		ղ c (%)
Class-B; CW	7.5	3.0	> typ.	7.0 8.5	> typ.	50 57



List of components:

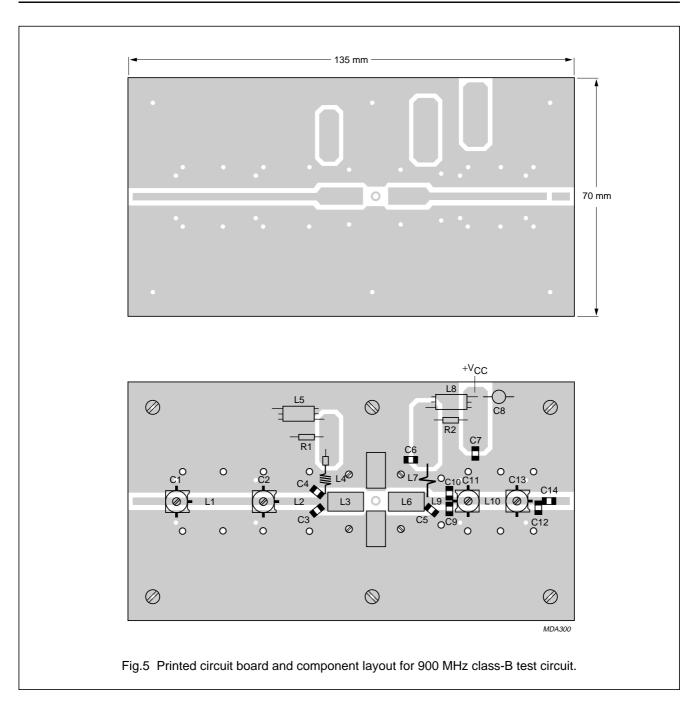
- C1 = C2 = C8 = C10 = 1.4 to 5.5 pF film dielectric trimmer (cat. no. 2222 809 09001)
- C3 = C6 = C7 = 3.3 pF multilayer ceramic chip capacitor⁽¹⁾
- C4 = C5 = C9 = 5.6 pF multilayer ceramic chip capacitor⁽¹⁾
- C11 = C12 = C13 = 180 pF multilayer ceramic chip capacitor
- C14 = $1 \mu F$ (35 V) tantalum capacitor
- L1 = 50Ω stripline (25 mm × 2.4 mm)
- L2 = 50Ω stripline (11 mm \times 2.4 mm)
- L3 = L4 = 25 Ω stripline (11.5 mm × 6.0 mm)
- L5 = 50Ω stripline (7.0 mm \times 2.4 mm)
- L6 = 50Ω stripline (27.0 mm \times 2.4 mm)
- L7 = 4 turns closely wound enamelled Cu wire (0.4 mm), int. dia;. 3 mm, with ferrite beat (cat. no. 4330 830 32221) over the coldside lead
- L8 = 1 turn Cu wire (1.0 mm); int. dia. 5.5 mm; length 2 mm; leads 2×5 mm
- L9 = L10 = Ferroxcube wideband HF choke, grade 3B (cat. no. 4312 020 36642)
- R1 = R2 = 10 $\Omega \pm 5\%$; 0.25 W metal film resistor

The striplines on a double Cu-clad printed circuit board with PTFE fibreglass dielectric (ϵ_r = 2.2); thickness 1/32 inch; thickness of copper-sheet 2 × 35 µm.

Note

1. American Technical Ceramics capacitor type 100 A or capacitor of same quality.

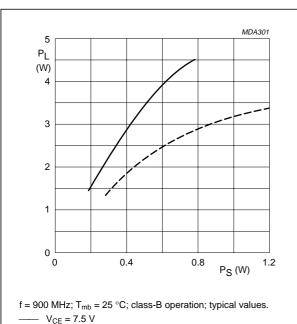
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Note:

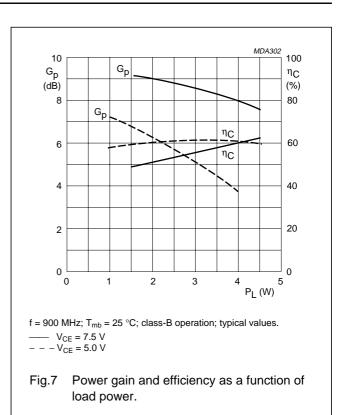
The circuit and the components are on one side of the PTFE fibreglass board; the other side is un-etched copper serving as groundplane. Earth connections are made by hollow rivets and also by fixing-screws and copper straps around the board and under the emitters to provide a direct contact between the copper on the component side and the groundplane.

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 $- - - V_{CE} = 5.0 V$

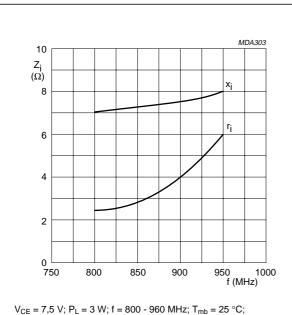
Fig.6 Load power as a function of source power.



RUGGEDNESS

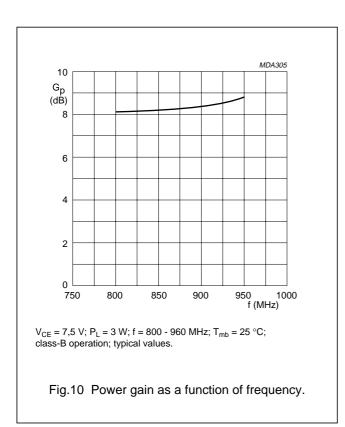
The device is capable of withstanding a full load mismatch (VSWR = 50; all phases) at rated load power up to a supply voltage of 9.0 V at T_{mb} = 25 °C.

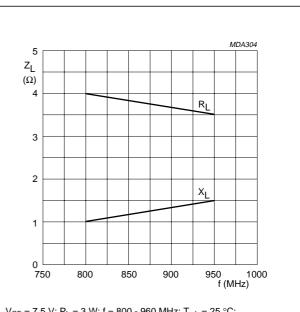
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class-B operation; typical values.

Fig.8 Input impedance as a function of frequency (series components).





 V_{CE} = 7,5 V; P_L = 3 W; f = 800 - 960 MHz; T_{mb} = 25 $^\circ C;$ class-B operation; typical values.

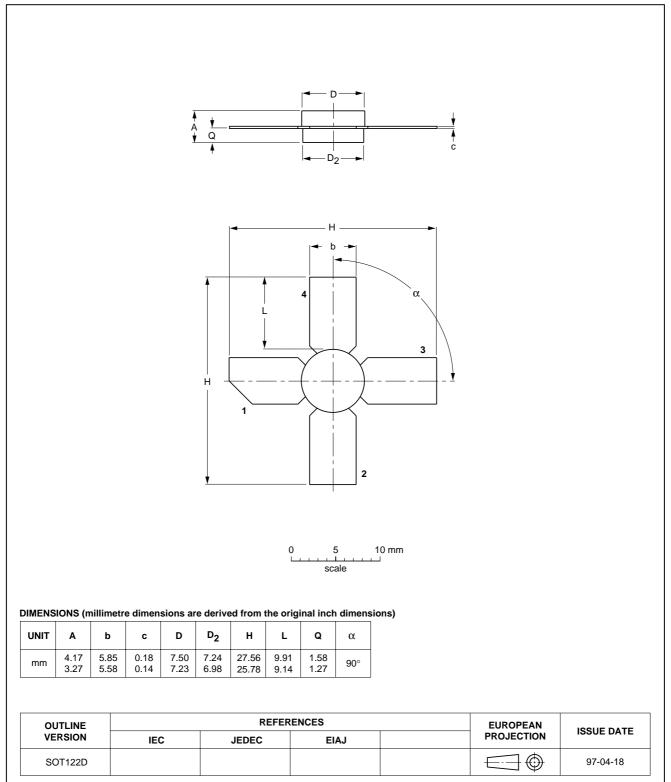
Fig.9 Load impedance as a function of frequency (series components).

Product specification

UHF power transistor

PACKAGE OUTLINE

Studless ceramic package; 4 leads



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SOT122D

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DEFINITIONS

Data Sheet Status			
Objective specification	This data sheet contains target or goal specifications for product development.		
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.		
Product specification	This data sheet contains final product specifications.		
Limiting values			
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.			

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

Product specification